



World's Smallest MEMS CSP TCXO for Mobile Applications

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SiTime – Leader in MEMS Timing





\$5 Billion
Timing Market

Market CAGR – 5% MEMS CAGR – 65%



MEMS, Analog, Systems Leader

100 Patents; 2-Year Lead



Market Leader

200MU Shipped, 100 Major OEMs 80% Share of MEMS Timing



Product Leader

Programmable – 200K Part Numbers ASP from \$0.30 – \$15

High-Volume Markets Using SiTime











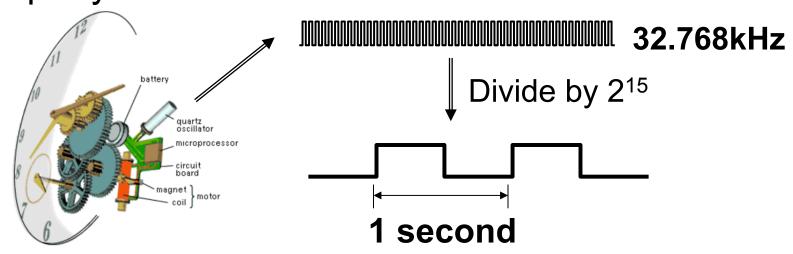




32kHz Clocks are Ubiquitous



 32.768kHz clock for time keeping; 6B units used per year

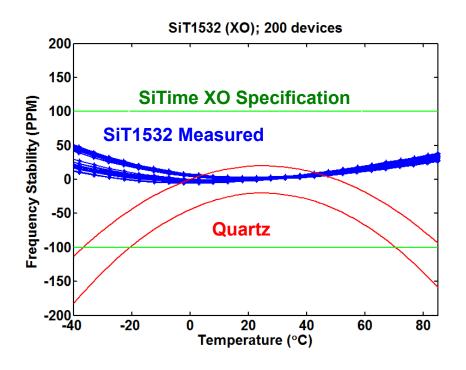


Requirements	Solution		
Small Size	→ MEMS Technology		
Low Power	→ + CMOS Techniques		
High Accuracy	→ + Temp Compensation Engine		

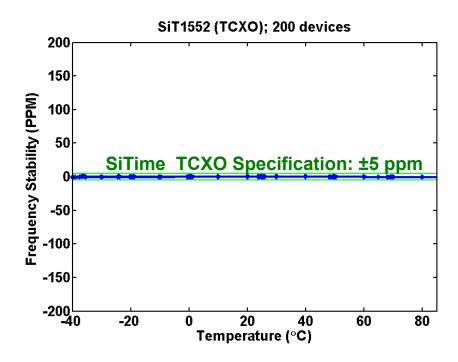
SiTime Delivers Best-in-Class Stability Time



SiT153x 32kHz XO (±100 ppm)



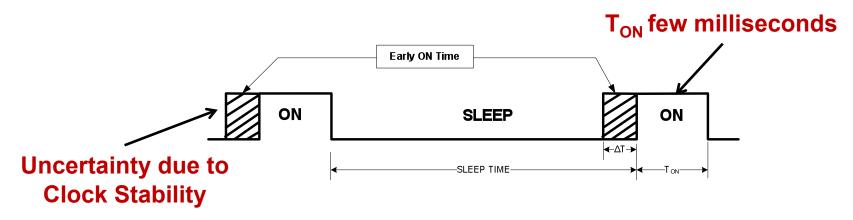
SiT1552 32kHz TCXO (±5 ppm)



5 ppm TCXO Extends Battery Life



- Clock Stability affects Early ON (ΔT)
 - ΔT = (Clock Stability) * (Sleep Time)
- Early ON time (ΔT) causes power penalty
- 5 ppm 32kHz sleep-clock enables longer sleep duration and maximizes battery life
- Tighter Stability → Longer Sleep Time → Lower Power

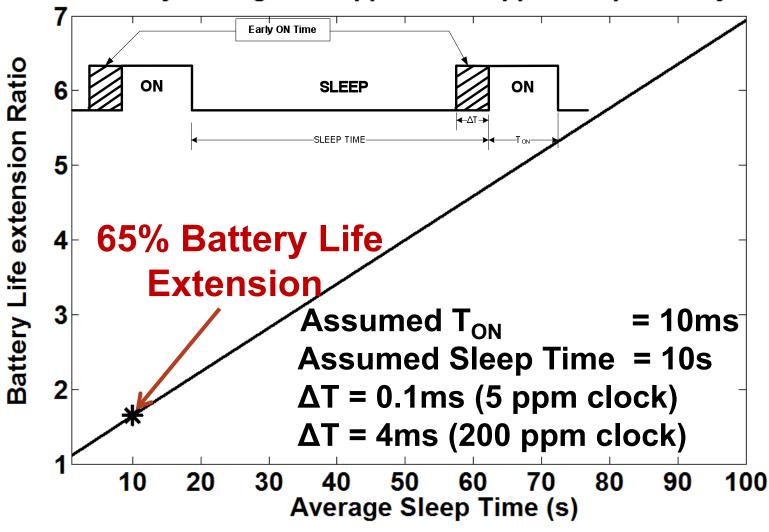


Average Power is proportional to the ratio of "ON" time to "Sleep" time

5 ppm TCXO Extends Battery Life



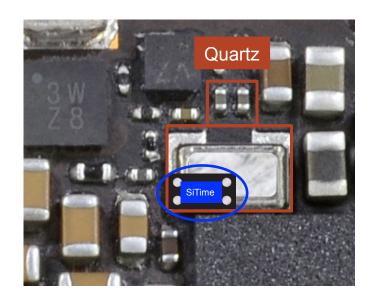




Smallest 32kHz XO in Production





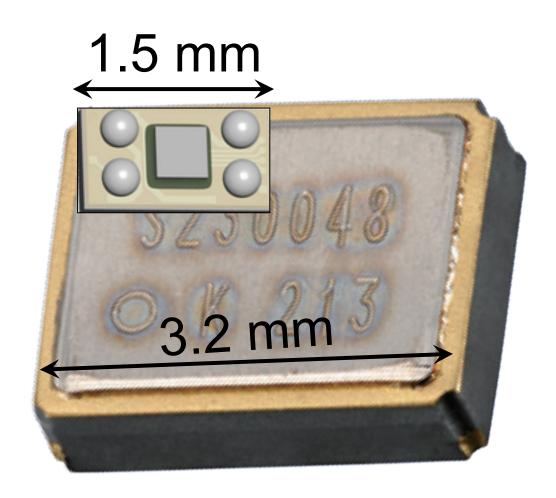




3.8x smaller than smallest XO!

Smallest 32kHz TCXO in Production





6x smaller than smallest 5ppm TCXO!

Size Comparison to Quartz Solutions Time

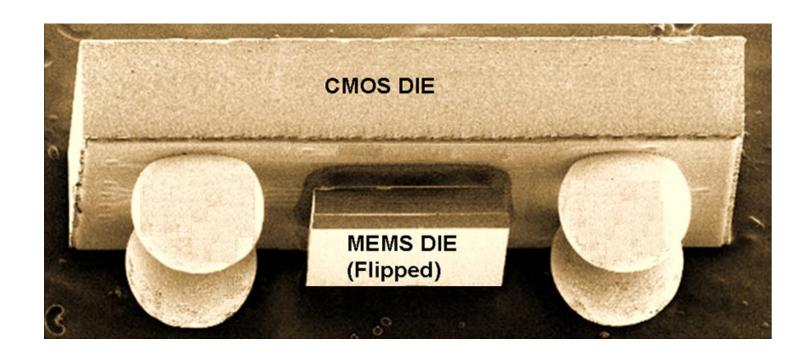


32kHz Clocking Solutions in Production

	SiTime TCXO	Smallest Quartz XO XTAL	Smallest Quartz TCXO
Package Footprint w/ Caps	1.3mm ²	5mm ²	10mm ²
Load Capacitors	No	Yes	No
Load Dependent Start-up	No	Yes	No
Bypass Caps	No	No	Yes

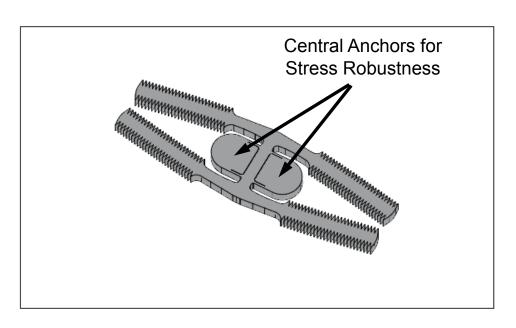
Inside the Smallest 32kHz TCXO



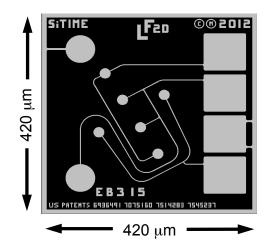


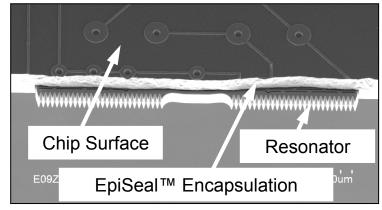
1.55mm x 0.85mm x 0.55mm length x width x height

524kHz TempFlat[™] MEMS Resonator **Time**



524kHz TempFlat™ MEMS Resonator

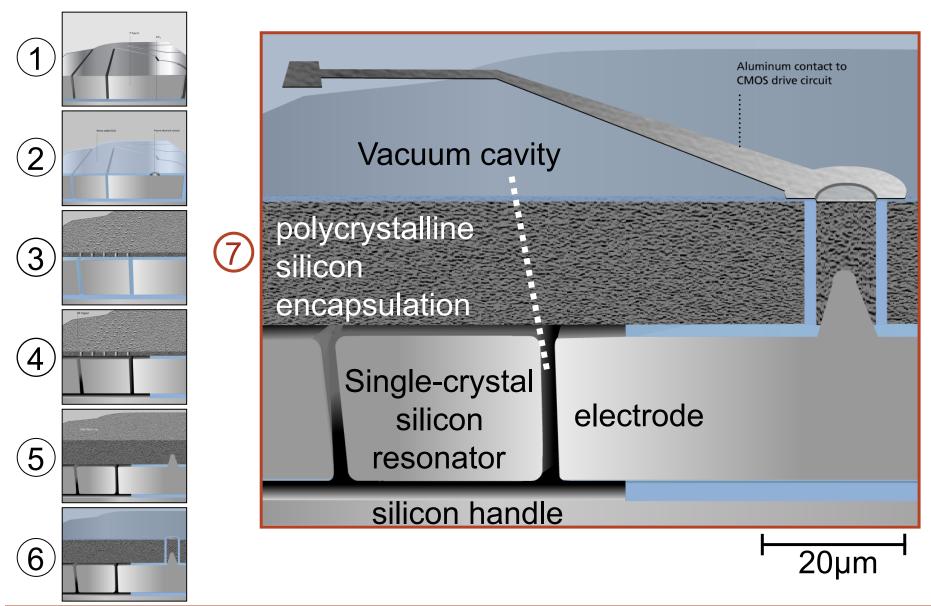




- Stable: Frequency within 100 ppm without temp sensor
- Reliable: No aging, no fatigue
- Manufacturable: Standard 200 mm CMOS fab

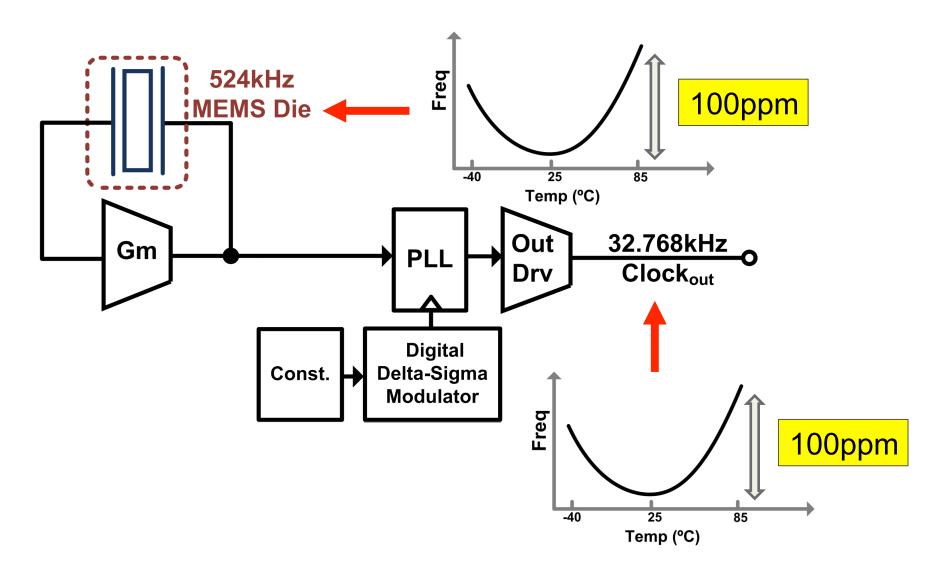
SiTime EpisealTM Encapsulation





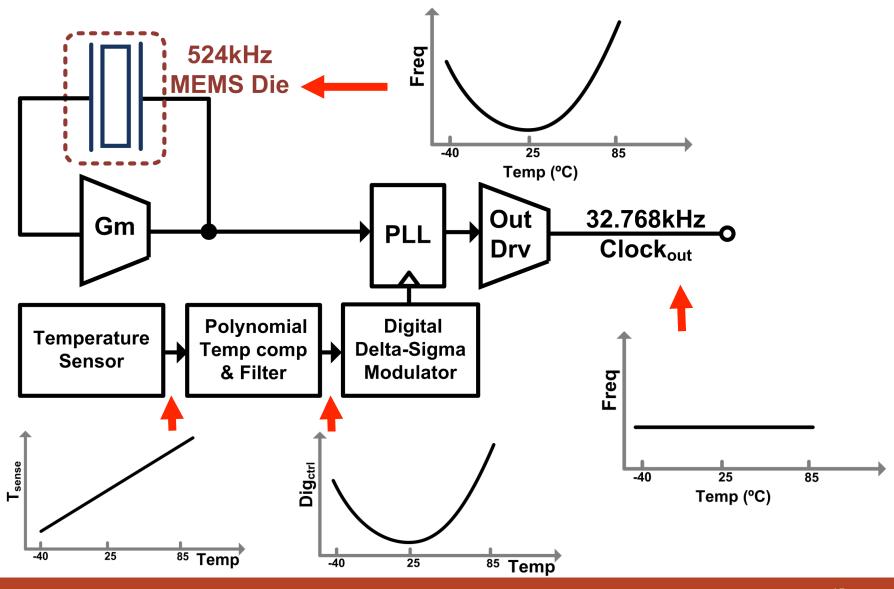
32kHz XO Architecture





32kHz TCXO Architecture

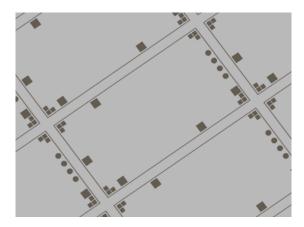




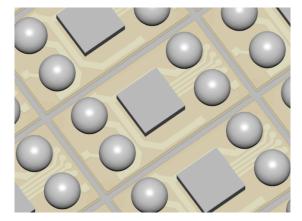
2-die CSP Packaging Flow



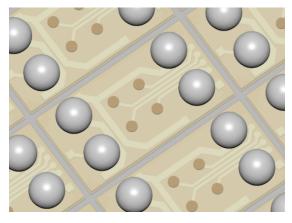
- All packaging steps are done at wafer level
- High die count per wafer enables high volume production



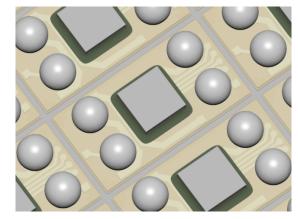
1. CMOS wafer



3. Flip-chip attach MEMS die



2. Solder ball mounting



4. Underfill application



5. Final test and singulation

CSP Construction Analysis



Flip-chip:

Shear strength: Cpk > 10

Daughter die repassivation:

CD tolerance: Cpk = 3.0

Flip-chip solder ball:

Height: Cpk = 2.75 Width: Cpk = 2.04 Shear: Cpk = 2.08

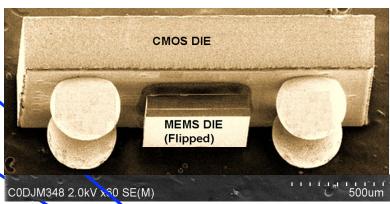
Package solder ball:

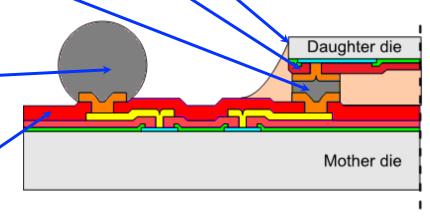
Height: Cpk = 2.96 Width: Cpk = 2.41 Shear: Cpk = 2.06

Mother die repassivation:

CD tolerance: Cpk = 4.5 min

1.55mm x 0.85mm x 0.55mm

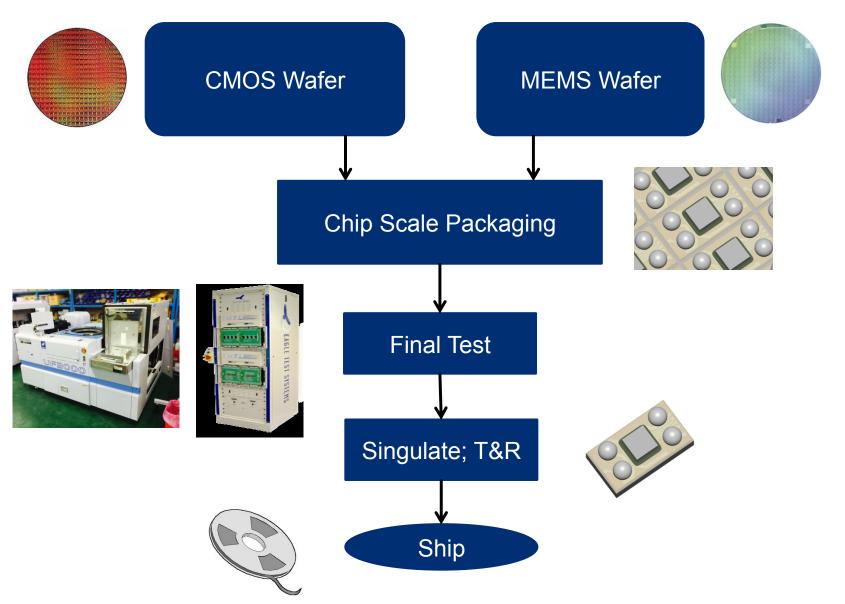




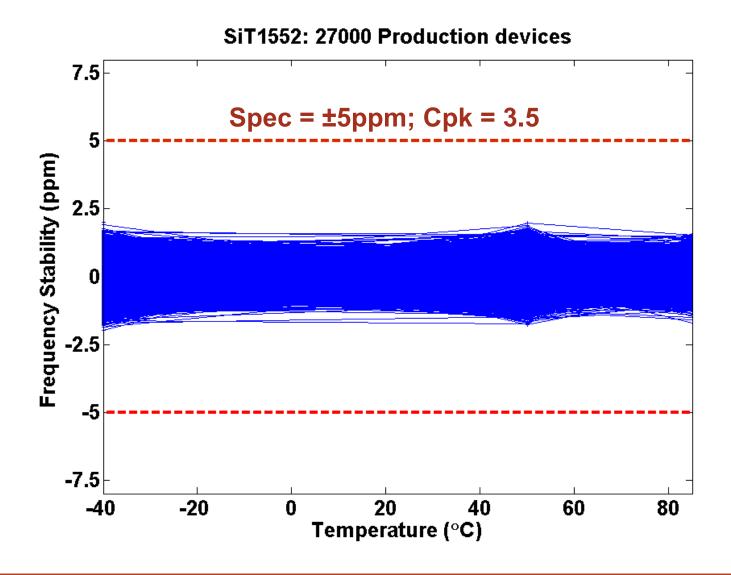
Package midline

Production Flow





Production Results: Frequency Stability SiTime



SiTime TCXO Specifications



Parameter	SiTime SiT1552	Kyocera KT3225T	Epson TG-3530
Frequency Stability (ppm)	± 5	± 5	± 5
Temperature Range (°C)	-40 to 85	-40 to 85	-20 to 70
Area (mm²)	1.3	8	50.5
Current (µA)	1 typ 1.5 max	1.5 typ 4 max	1.7 typ 4 max
Start up Time (s)	0.3	3	3
Supply Sensitivity (ppm/V)	± 0.25	± 1	± 1

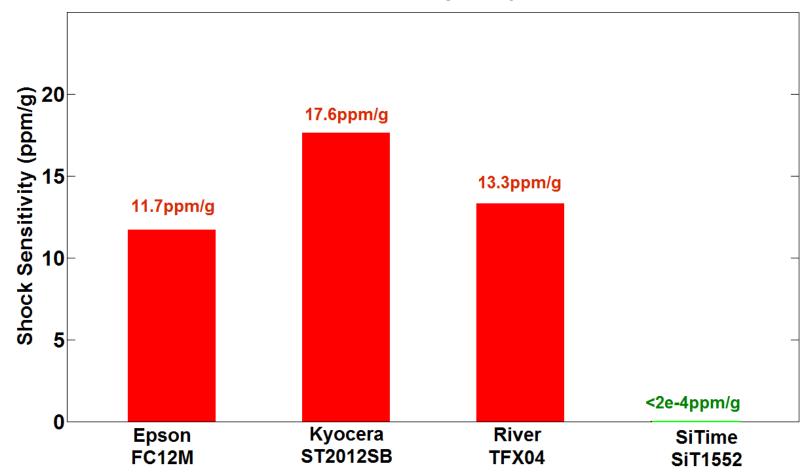




Shock Robustness

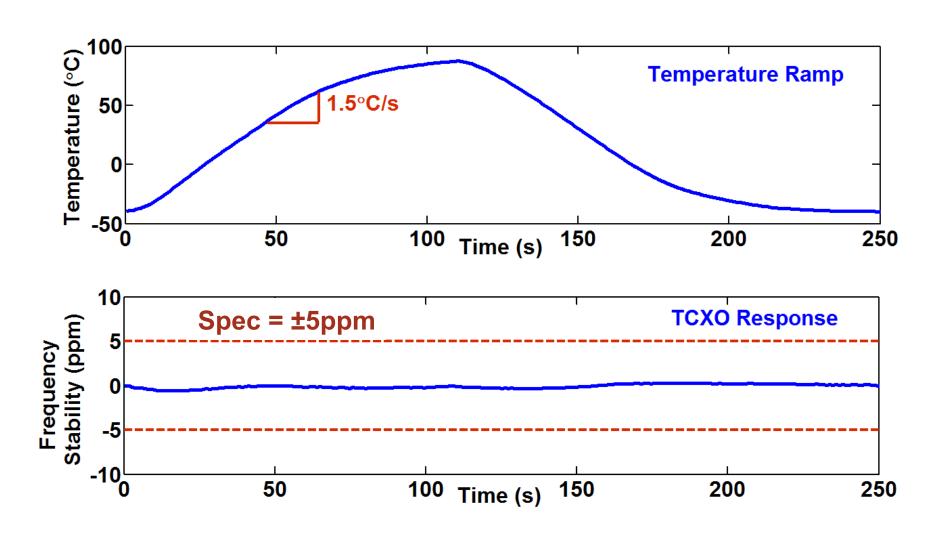


SiT1552 Shock Sensitivity Compared to Quartz



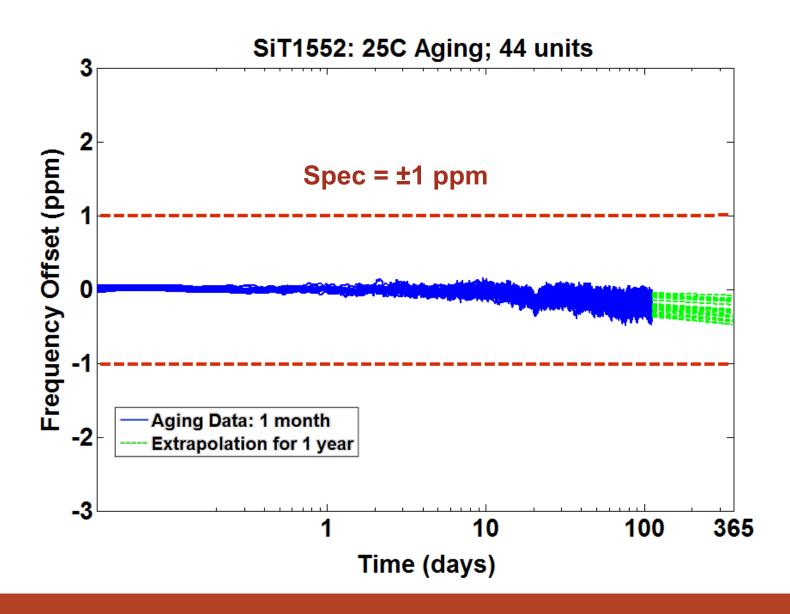
Fast Temperature Ramp Response





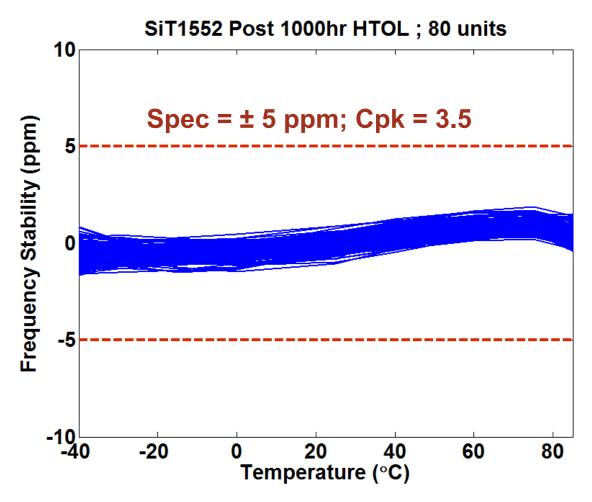
1-year Aging





High Temp Operating Life





<± 5 ppm after 1000 hours of High Temperature Operating Life (125°C)

In Conclusion...





- SiT1552 is the world's smallest and best-in-class production 32 kHz TCXO
- Enables increased functionality, smaller size and longer battery life in wearables, smartphones and other mobile devices





